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1827236-4 Product Details



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Memory Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Socket Type = Memory Card
 Socket Style = SO DIMM
 Gold Flash Contact Plating, Mating Area, Material 200 Positions
 DRAM Type = Double Data Rate (DDR) II

View all Features

(1827236)







Additional Information:

Related Products: Tooling

Documentation & Additional Information

Product Drawings:

DDR1 & DDR2 SODIMM SOCKET 0.6mm PITCH 200POS LOW PRO... (PDF, English)

Catalog Pages/Data Sheets:

Product Specifications:

• DDR S.O.DIMM Socket 200 Positions (PDF, English)

Application Specifications:

Instruction Sheets:

CAD Files: (CAD Format & Compression Information)

- 2D Drawing (DXF, Version F)
 3D Model (IGES, Version F)
- 3D Model (STEP, Version F)

List all Documents

Product Features (Please use the Product Drawing for all design activity)

- Product Type Features:

 Socket Style = SO DIMM
 DRAM Type = Double Data Rate (DDR) II
 - PCB Mount Style = Surface Mount
 - Module Orientation = Right Angle
 - Profile = Low
 - Comment = Latch direct soldering type.; See drawing for additional product information

Mechanical Attachment:

Keying = Standard

Electrical Characteristics:

DRAM Voltage = 1.8 \

Termination Related Features:

• Solder Tail Contact Plating = Gold Flash over Nickel

Body Related Features:

- Socket Type = Memory Card
- Number of Positions = 200
- Row-to-Row Spacing (mm [in]) = 5.60 [0.220]
- Centerline (mm [in]) = 0.60 [0.024]
- Number of Rows = Dual • Ejector Type = Locking
- <u>Ejector Location</u> = Both Ends
- Number of Keys = 1 Latch Material = Stainless Steel
- Latch Plating = Tin • Boss = With
- . Mount Type = Printed Circuit Board

- Contact Related Features: Contact Plating, Mating Area, Material = Gold Flash
 - Contact Base Material = Copper Alloy

- Housing Related Features:

 Housing Material = High Temperature Thermoplastic
 - UL Flammability Rating = UL 94V-0

Configuration Related Features:

- Stack Height (mm [in]) = 4.60 [0.180]
 Insertion Style = Cam-In
- Center Key (mm [in]) = None

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- <u>Lead Free Solder Processes</u> = Reflow solder capable to 245°C, Reflow solder capable to 260°C
- RoHS/ELV Compliance History = Always was RoHS compliant

- Operation/Application:
 Application Type = DDR SDRAM
- Packaging Related Features:

Packaging Method = Trav

Other:
• Brand = AMP

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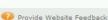
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